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## BGA stencil for Samsung Galaxy S3 (i9300)

Product ID: 21742

Price: **6.20 EUR**

Product weight: **0.02 kg**

### Description:

BGA stencil for Samsung Galaxy S3 (i9300) plating kit it's a BGA stencil matrix needed when you have to exchange BGA parts of your phone and wan't to apply BGA balls into IC.

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